

10/616,085

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-------|-------|---|---|------------------|---------|------------------|
| L1 | 2 | jp-2001139669-\$.did. | US-PGPU B; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/10/04 13:40 |
| L2 | 7 | (("5925934") or ("4042550") or ("6261871")).PN. | US-PGPU B; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/10/04 14:33 |
| L3 | 28809 | (flip adj chip) or flipchip | US-PGPU B; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/10/04 14:34 |
| L4 | 1649 | I3 near10 underfill\$3 | US-PGPU B; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/10/04 14:35 |

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|----|--------|--|---|----|----|------------------|
| L5 | 304689 | ((epox?\$3 or epoxidi?ed or epoxidat?\$1) near5 (novola?\$1 or resin)) or diepox?\$3 or polyepox?\$3 or diglycidyl\$ or polyglycidyl\$ | US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B | OR | ON | 2005/10/04 14:36 |
| L6 | 38274 | reflow | US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B | OR | ON | 2005/10/04 14:36 |
| L7 | 485 | underfill\$3 near7 I5 | US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B | OR | ON | 2005/10/04 14:37 |
| L8 | 141 | I4 and I7 and I6 | US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B | OR | ON | 2005/10/04 14:39 |

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|-----|-------|--|--|----|----|---------------------|
| L9 | 17402 | solder near7 reflow | US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B | OR | ON | 2005/10/04 14:39 |
| L10 | 111 | l4 and l7 and l9 | US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B | OR | ON | 2005/10/04 14:43 |
| L11 | 46557 | (maleic adj anhydride) near5 (polymer\$2 or resin or copolymer\$2 or oligomer\$2) | US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B | OR | ON | 2005/10/04 14:44 |
| L12 | 3 | l10 and l11 | US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B | OR | ON | 2005/10/04 15:11 |